## 507088907 01/24/2022

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 EPAS ID: PAT7135744

Stylesheet Version v1.2

SUBMISSION TYPE:NEW ASSIGNMENTNATURE OF CONVEYANCE:ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Shunpei Yamazaki	10/18/2010
Jun Koyama	10/19/2010
Kiyoshi Kato	10/20/2010

### **RECEIVING PARTY DATA**

Name:	SEMICONDUCTOR ENERGY LABORATORY CO., LTD.
Street Address:	398, HASE
City:	ATSUGI-SHI, KANAGAWA-KEN
State/Country:	JAPAN
Postal Code:	243-0036

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	17582092

### **CORRESPONDENCE DATA**

**Fax Number:** (877)769-7945

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided: if that is unsuccessful, it will be sent via US Mail.

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: (202) 783-5070
Email: apsi@fr.com
Correspondent Name: JOHN F. HAYDEN

Address Line 1: FISH & RICHARDSON P.C.

Address Line 2: P.O.BOX 1022

Address Line 4: MINNEAPOLIS, MINNESOTA 55440-1022

ATTORNEY DOCKET NUMBER: 12732-0726008

NAME OF SUBMITTER: SHARON M. ALLEN

SIGNATURE: /Sharon M. Allen/

DATE SIGNED: 01/24/2022

**Total Attachments: 1** 

source=12732-0726008 Assignment #page4.tif

507088907 PATENT REEL: 058737 FRAME: 0675

# **ASSIGNMENT**

For valuable consideration, We, <u>Shunpei YAMAZAKI of Setagaya</u>, <u>Tokyo</u>, <u>Japan, Jun KOYAMA of Sagamihara, Kanagawa, Japan and Kiyoshi KATO of Atsugi, Kanagawa, Japan hereby assign to <u>Semiconductor Energy Laboratory Co., Ltd.</u>, a <u>Japanese</u> corporation having a place of business at:</u>

398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan

and its s	uccessors	and ass	igns (col	lectively	hereinaf	fter cal	led "the A	Assig	nee"),	the e	ntire r	ight, tit	le and
interest t	hroughou	t the wo	rld in the	inventio	ons and i	improve	ements wi	nich a	are sul	oject o	of an a	pplicati	on for
United	States	Patent	signed	by us	this	day,	entitled	SEN	<u> </u>	NDU(	CTOR	DE)	VICE,
filed	10/28	/2010	, ar	nd assign	ed U.S.	Serial	Number	_1	2/91	4,6	72	, a	nd we
authorize	and requ	iest the a	ittorneys	appointe	d in said	applic	ation to h	ereaf	ter co	mplete	this a	ssignm	ent by
inserting	above the	e filing d	ate and se	erial num	ber of sa	id appl	lication wl	hen k	nown;	this a	ssignn	nent inc	luding
said app	lication, a	any and	all Unite	d States	and fore	eign pa	itents, util	lity n	nodels	, and	design	regist	rations
granted f	or any of	said inve	ntions or	improve	ments, ar	nd the r	ight to cla	im p	riority	based	on the	filing	date of
said app	lication u	nder the	Internati	onal Cor	vention	for the	e Protection	on of	Indu	strial :	Proper	ty, the	Patent
Cooperat	ion Treat	y, the E	turopean	Patent C	Conventio	on, and	d all othe	r trea	aties o	of like	purpo	oses; a	nd we
authorize	the Assi	gnee to a	pply in a	Il countri	ies in ou	r name	or in its	own i	name	for pat	ents, u	itility m	odels,
design re	egistration	ıs and li	ke rights	of excl	usion an	d for	inventors'	certi	ficates	for s	said in	ventior	rs and
improver	nents; an	d we ag	ree for c	ourselves	and our	respe	ctive heir	s, le	gal rep	oresen	tatives	and as	ssigns,
without f	urther cor	npensatio	on to perf	orm such	lawful a	acts and	d to sign s	uch f	urther	applic	ations,	assign	ments,
Prelimina	ary Staten	nents and	l other la	wful doc	uments	as the	Assignee	may	reason	ably r	equest	to effe	ectuate
fully this	assignme	nt.											

Signature	Ships Jeph
Name:	Shunpei YAMAZAKI
Date:	10/18/2010
Signature Name: Date:	Jun Hoyama KUKOYAMA 10/19/2010
Signature Name:	Kiyoshi Kato Kiyoshi KATO
Date:	10/20/20/0

**RECORDED: 01/24/2022** 

PATENT REEL: 058737 FRAME: 0676